

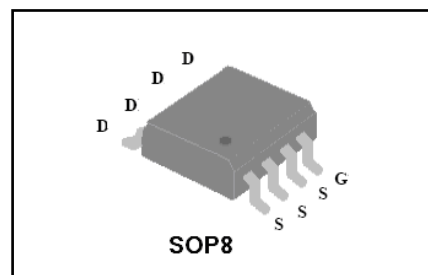
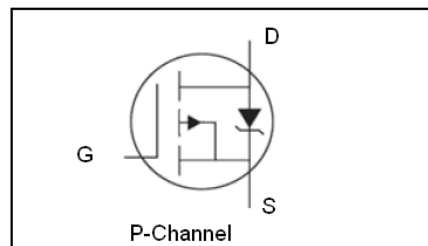
## Features

- ◆ P-CH: -30V/-7.8A,  $R_{DS(ON)}=18m\Omega$
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ Lead-Free, Green Product

## Description

VS4435AS designed by the trench processing techniques to achieve extremely low on-resistance. And fast switching speed and improved transfer effective. These features combine to make this design an extremely efficient and reliable device for variety of DC-DC applications.

## Pin Description



## Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
<b>Common Ratings (<math>T_C=25^\circ\text{C}</math> Unless Otherwise Noted)</b>				
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage		-30	V
$T_J$	Maximum Junction Temperature		150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-50 to 150	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_A=25^\circ\text{C}$	-2	A
<b>Mounted on Large Heat Sink</b>				
$I_{DM}$	Pulse Drain Current Tested①	$T_A=25^\circ\text{C}$	-30	A
$I_D$	Continuous Drain Current( $V_{GS}=-10\text{V}$ )	$T_A=25^\circ\text{C}$	-7.8	A
		$T_A=100^\circ\text{C}$	-5	
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	2	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		25	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		62.5	$^\circ\text{C/W}$
<b>Drain-Source Avalanche Ratings</b>				
EAS	Avalanche Energy, Single Pulsed ②		24	mJ

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>Gs</sub> =0V, I <sub>D</sub> =-250μA	-30	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (T <sub>J</sub> =25°C)	V <sub>Ds</sub> =-30V, V <sub>Gs</sub> =0V	--	--	-1	μA
	Zero Gate Voltage Drain Current (T <sub>J</sub> =125°C)	V <sub>Ds</sub> =-30V, V <sub>Gs</sub> =0V	--	--	-100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>Gs</sub> =±20V, V <sub>Ds</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>Ds</sub> =V <sub>Gs</sub> , I <sub>D</sub> =-250μA	-1.0	-1.5	-2.5	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>Gs</sub> =-10V, I <sub>D</sub> =-8A	--	18	25	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>Gs</sub> =-4.5V, I <sub>D</sub> =-4A	--	25	35	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>Ds</sub> =-15V, V <sub>Gs</sub> =0V, f=1MHz	--	1380	--	pF
C <sub>oss</sub>	Output Capacitance		--	165	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	110	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>Ds</sub> =-12V, I <sub>D</sub> =-4A, V <sub>Gs</sub> =-10V	--	18	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	2.6	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	7.8	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =-15V, I <sub>D</sub> =-6A, R <sub>G</sub> =3.3Ω, V <sub>Gs</sub> =-4.5V	--	8.6	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	7.5	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	35	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	32	--	nS
<b>Source- Drain Diode Characteristics</b>						
V <sub>SD</sub>	Forward on voltage	T <sub>J</sub> =25°C, I <sub>SD</sub> =-7.8A V <sub>Gs</sub> =0V	--	-0.83	-1.0	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>J</sub> =25°C, I <sub>sd</sub> =-5A, V <sub>Gs</sub> =0V	--	23	--	nS
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=-100A/μs	--	10	--	nC

Note: ① Repetitive rating; pulse width limited by max. junction temperature.

② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.1mH, R<sub>G</sub> = 25Ω, I<sub>As</sub> = -22A, V<sub>Gs</sub> = -10V. Part not recommended for use above this value

③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

P-Channel Typical Characteristics

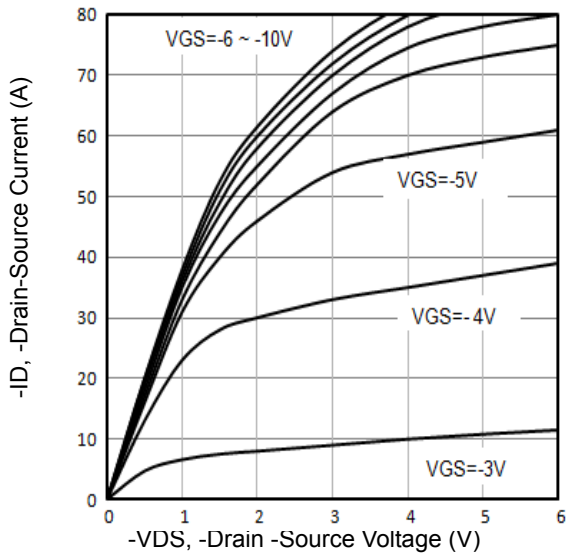


Fig1. Typical Output Characteristics

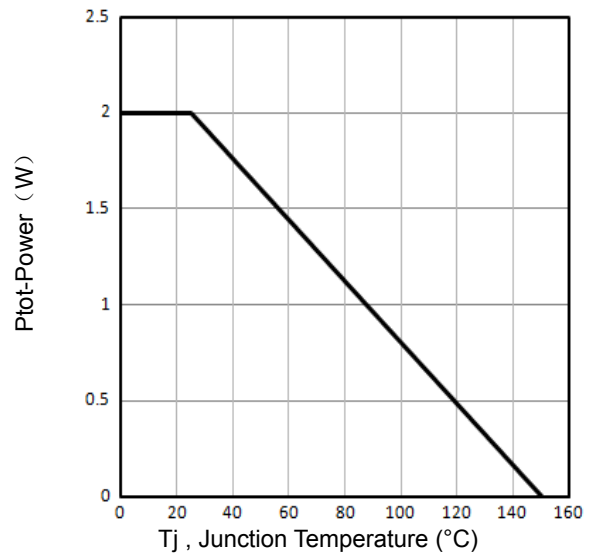


Fig2. Power Dissipation

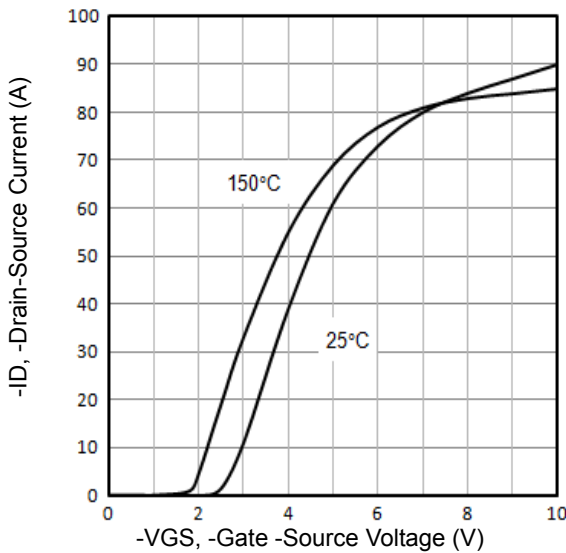


Fig3. Typical Transfer Characteristics

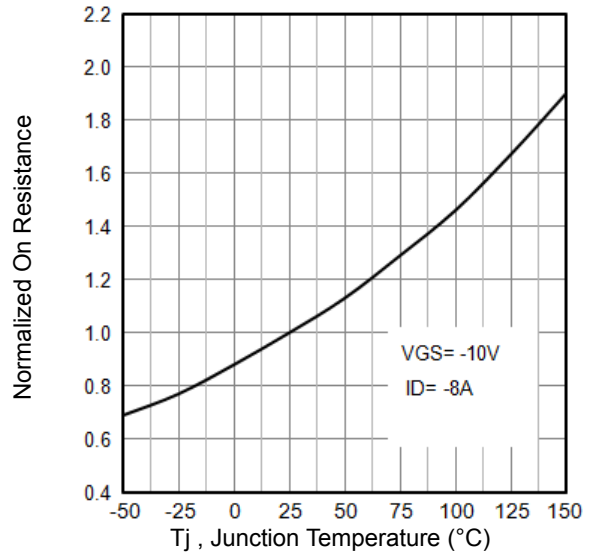


Fig4. Normalized On-Resistance Vs. Temperature

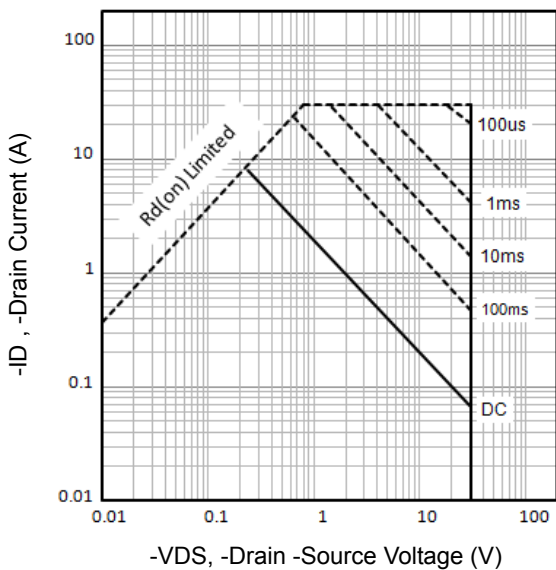


Fig5. Maximum Safe Operating Area

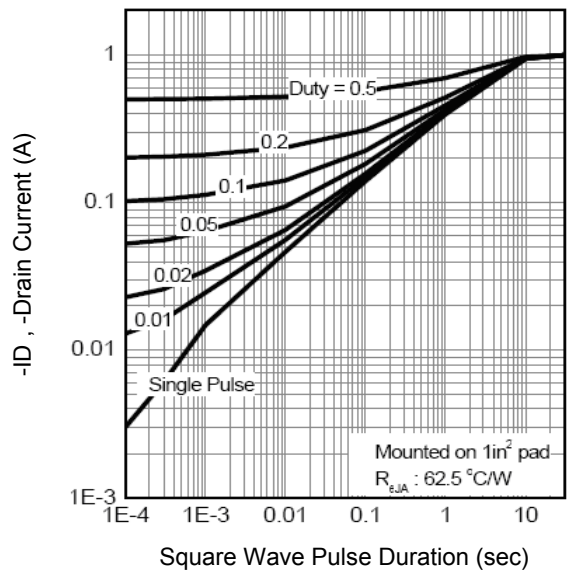


Fig6. Thermal Transient Impedance

P-Channel Typical Characteristics

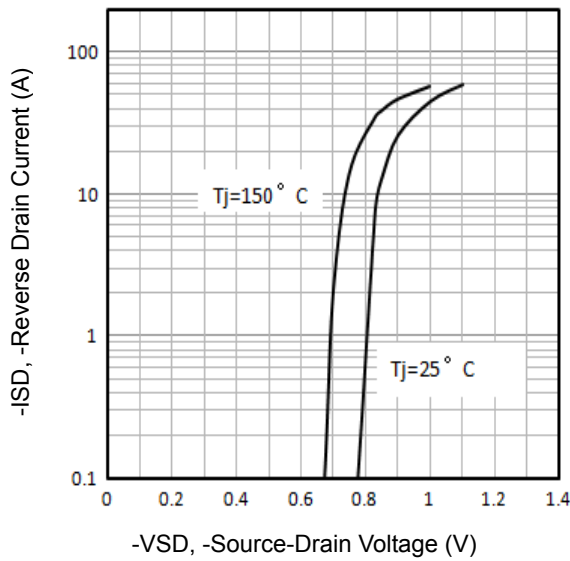


Fig7. Typical Source-Drain Diode Forward Voltage

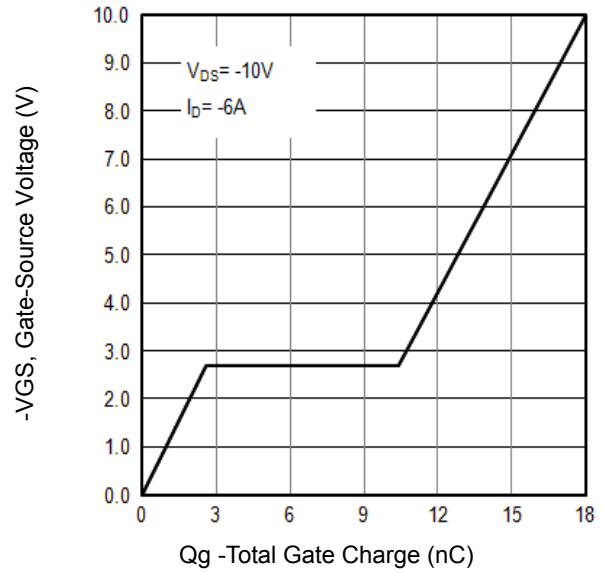


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

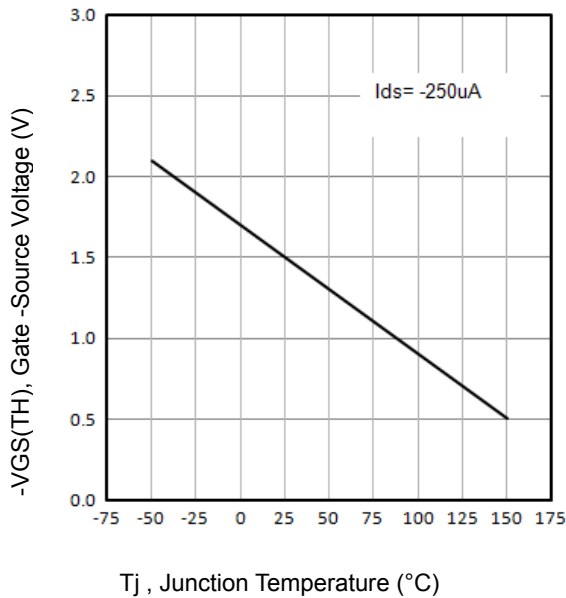


Fig9. Threshold Voltage Vs. Tj

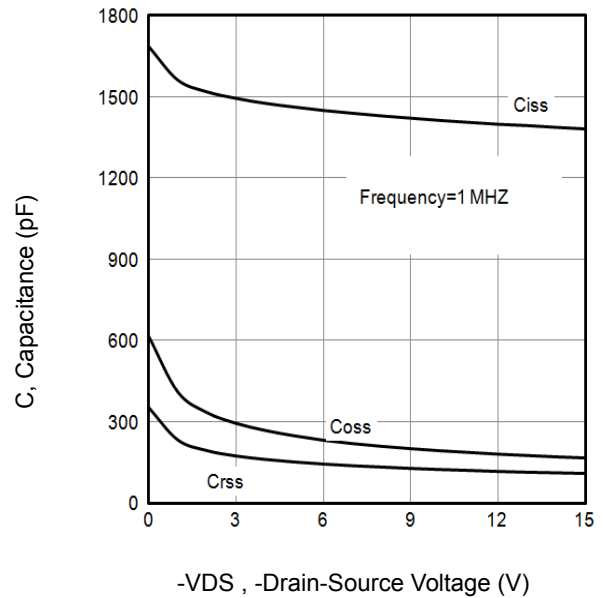


Fig10. Typical Capacitance Vs. Drain-Source Voltage

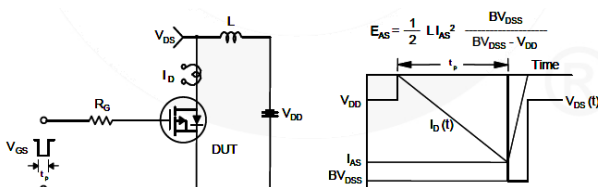


Fig11. Unclamped Inductive Test Circuit and waveforms

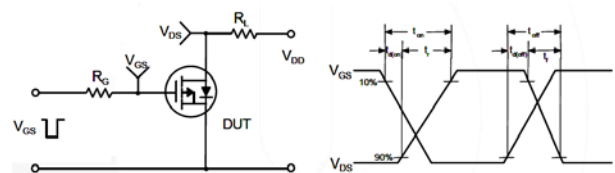
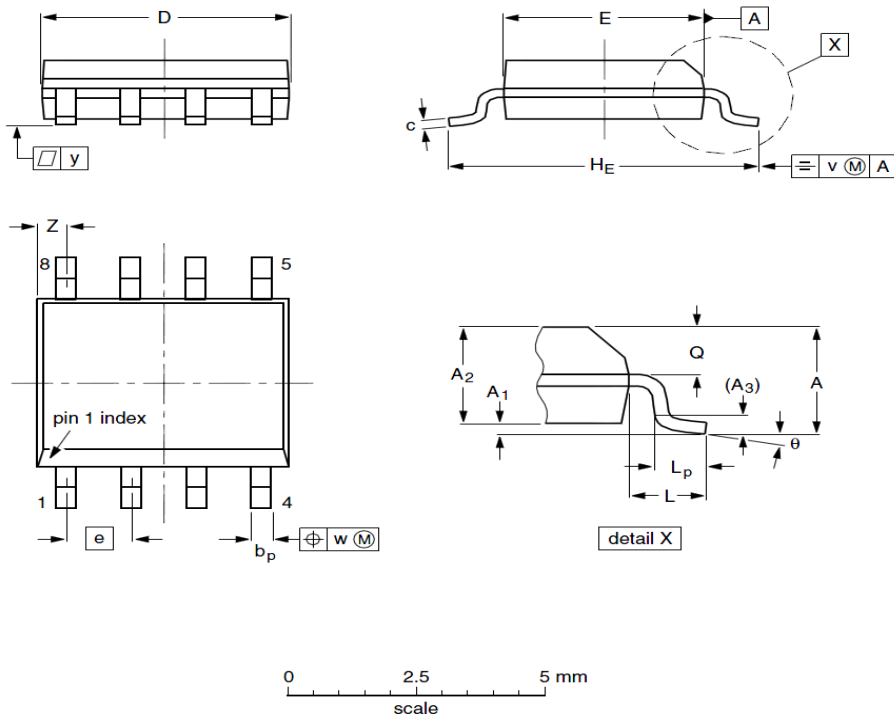


Fig12. Switching Time Test Circuit and waveforms

SOP8 Package Outline Data



DIMENSIONS ( unit : mm )

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	--	1.75	--	A <sub>1</sub>	0.10	0.18	0.25
A <sub>2</sub>	1.25	1.35	1.45	A <sub>3</sub>	--	0.25	--
b <sub>p</sub>	0.36	0.42	0.49	c	0.19	0.22	0.25
D	4.80	4.92	5.00	E	3.80	3.90	4.00
e	--	1.27	--	H <sub>E</sub>	5.80	5.98	6.20
L	--	1.05	--	L <sub>p</sub>	0.40	0.68	1.00
Q	0.60	0.65	0.70	v	--	0.25	--
w	--	0.25	--	y	--	0.10	--
Z	0.30	0.50	0.70	θ	0°		8°

Order Information

Product	Marking	Package	Packaging	Min Unit Quantity
VS4435AS	VS4435AS	SOP8	3000/Reel	6000

Customer Service

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